

L Number	Hits	Search Text	DB	Time stamp
1	6	((("6092851") or ("6268030") or ("6237979"))).PN.	USPAT; EPO; JPO; DERWENT	2004/03/08 03:47
2	2710	(wafer or substrate or semiconductor or glass or negative or film) near15 ((holder or jig or carrier of boat or rack) near15 wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 03:50
3	2710	(wafer or substrate or semiconductor or glass or negative or film) near15 ((holder or jig or carrier of boat or rack) near15 wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 04:27
4	271	(wafer or substrate or semiconductor or glass or negative or film) near15 ((holder or jig or carrier of boat or rack) near15 wire)	USOCR	2004/03/08 03:50
5	1994	(wafer or substrate or semiconductor or glass or negative or film) near15 ((holder or jig or carrier of boat or rack) near8 wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 03:51
6	1994	(wafer or substrate or semiconductor or glass or negative or film) near15 ((holder or jig or carrier of boat or rack) near8 wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 03:51
7	31	(wafer or substrate or semiconductor or glass or negative or film) near15 ((holder or jig or carrier of boat or rack) near8 wire) same (wash or washing or clean or cleaning or rinse or rinsing or decontaminate or decontamination or decontaminating)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 03:53
8	27	(wafer or substrate or semiconductor or glass or negative or film) near8 ((holder or jig or carrier of boat or rack) near8 wire) same (wash or washing or clean or cleaning or rinse or rinsing or decontaminate or decontamination or decontaminating)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 03:55
9	1776	(wafer or substrate or semiconductor or glass or negative or film) near8 ((holder or jig or carrier of boat or rack) near8 wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 03:56
10	1201	(wafer or substrate or semiconductor) near8 ((holder or jig or carrier of boat or rack) near8 wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 03:57
11	816	(wafer or substrate or semiconductor) near8 ((holder or jig or carrier of boat or rack) near5 wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 04:16
12	816	(wafer or substrate or semiconductor) near8 ((holder or jig or carrier of boat or rack) near5 wire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 04:27
13	73	((wafer or substrate or semiconductor or glass or negative or film) near10 ((holder or jig or carrier of boat or rack) near10 wire)) and (206/\$.ccls. or 156/\$.ccls. or 211/\$.ccls. or 396/\$.ccls. or 134/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 04:36

14	35	((wafer or substrate or semiconductor or glass or negative or film) near10 ((holder or jig or carrier of boat or rack) near10 wire)) and (118/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 04:36
15	31	((wafer or substrate or semiconductor or glass or negative or film) near10 ((holder or jig or carrier of boat or rack) near10 wire)) and (206/\$.ccls. or 156/\$.ccls. or 211/\$.ccls. or 396/\$.ccls. or 134/\$.ccls. or 118/\$.ccls.)	USOCR	2004/03/08 04:37
16	33	((wafer or substrate or semiconductor or glass or negative or film) near10 ((holder or jig or carrier of boat or rack) near10 wire)) and (206/\$.ccls. or 156/\$.ccls. or 211/\$.ccls. or 396/\$.ccls. or 134/\$.ccls. or 118/\$.ccls.)	USOCR	2004/03/08 04:38
17	1	((wafer or substrate or semiconductor or glass or negative or film) near10 ((caddy) near10 wire)) and (206/\$.ccls. or 156/\$.ccls. or 211/\$.ccls. or 396/\$.ccls. or 134/\$.ccls. or 118/\$.ccls.)	USOCR	2004/03/08 04:39
18	0	((wafer or substrate or semiconductor or glass or negative or film) near10 ((caddy) near10 wire)) and (206/\$.ccls. or 156/\$.ccls. or 211/\$.ccls. or 396/\$.ccls. or 134/\$.ccls. or 118/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 04:39
-	225	211/41.18.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 02:58
-	4	211/41.18.ccls.	USOCR	2004/03/08 02:58
-	69	206/832.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 03:46